

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHENG-CHOU HUNG	12/23/2014
MING-TZONG YANG	12/23/2014
TUNG-HSING LEE	12/23/2014
WEI-CHE HUANG	12/23/2014
YU-HUA HUANG	12/23/2014
TZU-HUNG LIN	12/23/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	MEDIATEK INC.
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<b>City:</b>	HSIN-CHU
<b>State/Country:</b>	TAIWAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	15365435
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<b>ATTORNEY DOCKET NUMBER:</b>	251325-5582
<b>NAME OF SUBMITTER:</b>	DANIEL R. MCCLURE
<b>SIGNATURE:</b>	/Daniel R. McClure/
<b>DATE SIGNED:</b>	11/30/2016

**Total Attachments: 2**

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ASSIGNMENT

WHEREAS, Cheng-Chou HUNG, Ming-Tzong YANG, Tung-Hsing LEE, Wei-Che HUANG, Yu-Hua HUANG and Tzu-Hung LIN

hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SEMICONDUCTOR PACKAGE STRUCTURE AND METHOD FOR FORMING THE SAME

Filed: \_\_\_\_\_ Serial No. \_\_\_\_\_

Executed on: \_\_\_\_\_

WHEREAS, MediaTek Inc. of No. 1, Dusing Rd. 1<sup>st</sup>, Science-Based Industrial Park, Hsin-Chu 300, Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Cheng-Chou Hung  
Cheng-Chou HUNG

12/23 2014  
Date

Ming-Tzong Yang  
Ming-Tzong YANG

12/23 2014  
Date

ASSIGNMENT

Tung-Hsing Lee  
Tung-Hsing LEE

2014/12/23  
Date

Wei-Che Huang  
Wei-Che HUANG

2014/12/23  
Date

Yu-Hua Huang  
Yu-Hua HUANG

2014, 12, 23  
Date

Tzu-Hung Lin  
Tzu-Hung LIN

2014. 12. 23  
Date